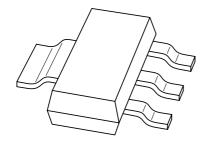
## **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# PBSS4350Z50 V low V<sub>CEsat</sub> NPN transistor

Product specification Supersedes data of 2003 Jan 20 2003 May 13





## 50 V low V<sub>CEsat</sub> NPN transistor

**PBSS4350Z** 

## **FEATURES**

- · Low collector-emitter saturation voltage
- High collector current capability: I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (hFE) at high IC
- Higher efficiency leading to less heat generation
- Reduced PCB area requirements compared to DPAK.

## **APPLICATIONS**

- · Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - Linear voltage regulation (LDO).
- Peripheral drivers
  - Driver in low supply voltage applications, e.g. lamps, LFDs
  - Inductive load driver, e.g. relays, buzzers, motors.

#### **DESCRIPTION**

NPN low  $V_{\text{CEsat}}$  transistor in a SOT223 plastic package. PNP complement: PBSS5350Z.

#### **MARKING**

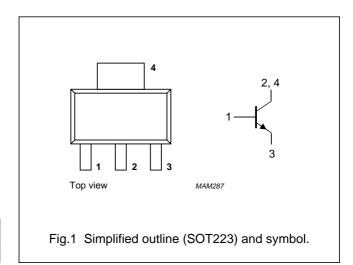
TYPE NUMBER	MARKING CODE
PBSS4350Z	PB4350

## **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	50	V
I <sub>CM</sub>	peak collector current	5	Α
R <sub>CEsat</sub>	equivalent on-resistance	<145	mΩ

#### **PINNING**

PIN	DESCRIPTION	
1	base	
2	collector	
3	emitter	
4	collector	



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## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	60	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	6	٧
I <sub>C</sub>	collector current (DC)		_	3	Α
I <sub>CM</sub>	peak collector current		_	5	А
I <sub>BM</sub>	peak base current		_	1	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; notes 1 and 3	_	1.35	W
		T <sub>amb</sub> ≤ 25 °C; notes 2 and 3	_	2	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

## **Notes**

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm<sup>2</sup>.
- 3. For other mounting conditions see "Thermal considerations for SOT223 in the General Part of associated Handbook".

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; notes 1 and 3	92	K/W
		in free air; notes 2 and 3	62.5	K/W

#### **Notes**

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm<sup>2</sup>.
- 3. For other mounting conditions see "Thermal considerations for SOT223 in the General Part of associated Handbook".

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## **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

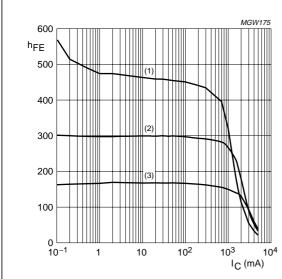
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0	_	_	100	nA
		V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0; T <sub>j</sub> = 150 °C	_	_	50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 500 mA	200	_	_	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 1 A; note 1	200	_	_	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 2 A; note 1	100	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	_	_	90	mV
	voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA	_	_	170	mV
		$I_C = 2 \text{ A}$ ; $I_B = 200 \text{ mA}$ ; note 1	_	_	290	mV
R <sub>CEsat</sub>	equivalent on-resistance	I <sub>C</sub> = 2 A; I <sub>B</sub> = 200 mA; note 1	_	110	<145	mΩ
$V_{BEsat}$	base-emitter saturation voltage	I <sub>C</sub> = 2 A; I <sub>B</sub> = 200 mA; note 1	_	_	1.2	V
$V_{BEon}$	base-emitter turn-on voltage	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 1 A; note 1	_	_	1.1	V
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 100 mA; V <sub>CE</sub> = 5 V; f = 100 MHz	100	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	30	pF

## Note

<sup>1.</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

## 50 V low V<sub>CEsat</sub> NPN transistor

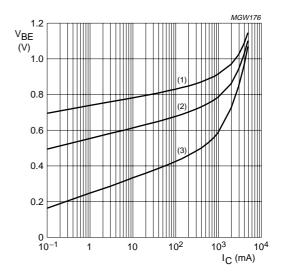
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 $V_{CE} = 2 V$ .

- (1) T<sub>amb</sub> = 150 °C.
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

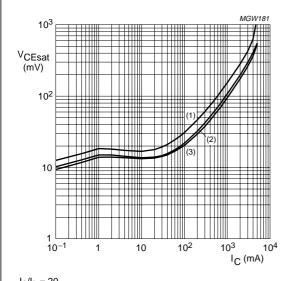
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

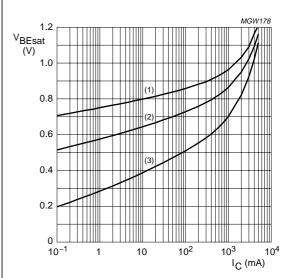
Fig.3 Base-emitter voltage as a function of collector-current; typical values.



 $I_{\rm C}/I_{\rm B}=20.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.4 Collector-emitter saturation as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20$ .

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- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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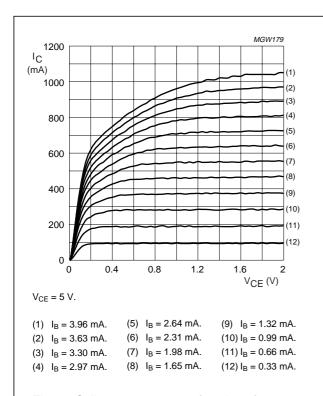
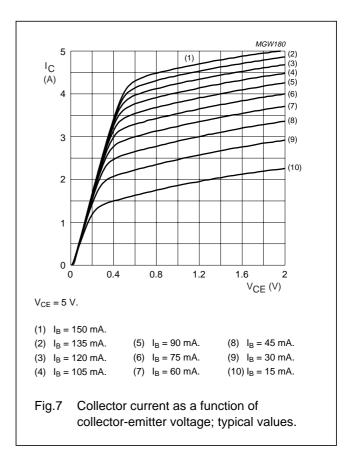
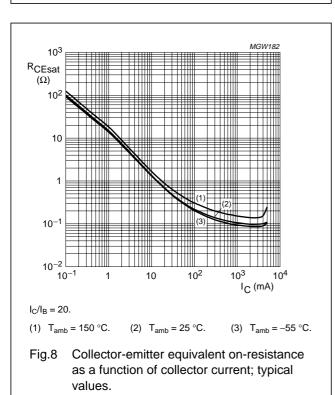


Fig.6 Collector current as a function of collector-emitter voltage; typical values.





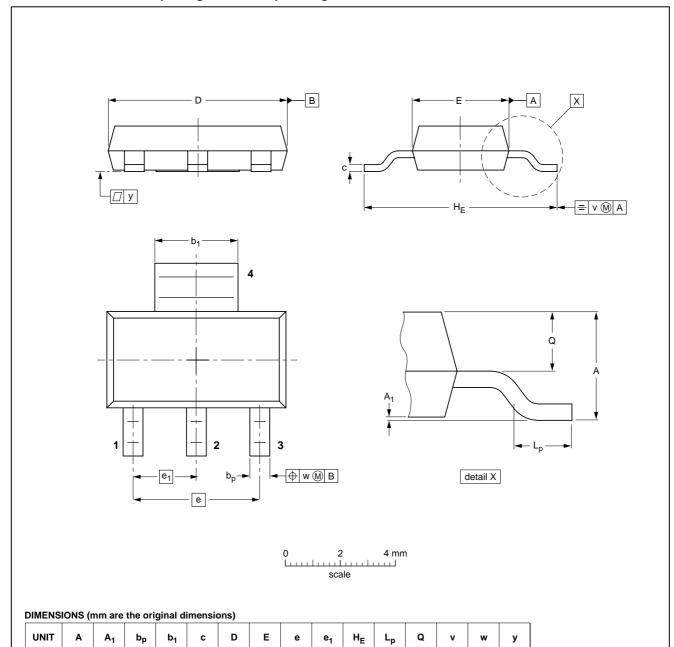
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## **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

**SOT223** 



OUTLINE	REFERENCES EUROPEAN ISSE			ICCUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT223			SC-73		<del>-97-02-28</del> 99-09-13

0.95

0.85

0.2

0.1

0.1

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0.80

0.60

1.8

1.5

mm

0.10

0.01

3.1 2.9 0.32 0.22 6.7 6.3 3.7 3.3

4.6

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LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
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NOTES

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NOTES

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